

TLC7528C, TLC7528E, TLC7528I DUAL 8-BIT MULTIPLYING DIGITAL-TO-ANALOG CONVERTERS

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- Easily Interfaced to Microprocessors
- On-Chip Data Latches
- Monotonic Over the Entire A/D Conversion Range
- Interchangeable With Analog Devices AD7528 and PMI PM-7528
- Fast Control Signaling for Digital Signal Processor (DSP) Applications Including Interface With TMS320
- Voltage-Mode Operation
- CMOS Technology

| KEY PERFORMANCE SPECIFICATIONS | |
|---|--------|
| Resolution | 8 bits |
| Linearity Error | 1/2LSB |
| Power Dissipation at $V_{DD} = 5V$ | 20mW |
| Settling Time at $V_{DD} = 5V$ | 100ns |
| Propagation Delay Time at $V_{DD} = 5V$ | 80ns |

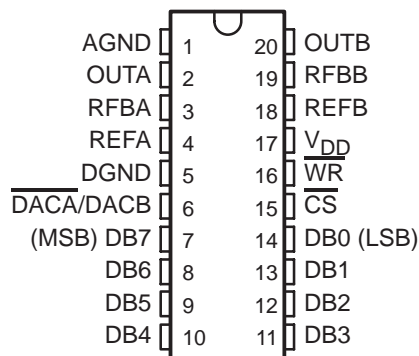
description

The TLC7528C, TLC7528E, and TLC7528I are dual, 8-bit, digital-to-analog converters (DACs) designed with separate on-chip data latches and feature exceptionally close DAC-to-DAC matching. Data are transferred to either of the two DAC data latches through a common, 8-bit, input port. Control input $\overline{DACA/DACB}$ determines which DAC is to be loaded. The load cycle of these devices is similar to the write cycle of a random-access memory, allowing easy interface to most popular microprocessor buses and output ports. Segmenting the high-order bits minimizes glitches during changes in the most significant bits, where glitch impulse is typically the strongest.

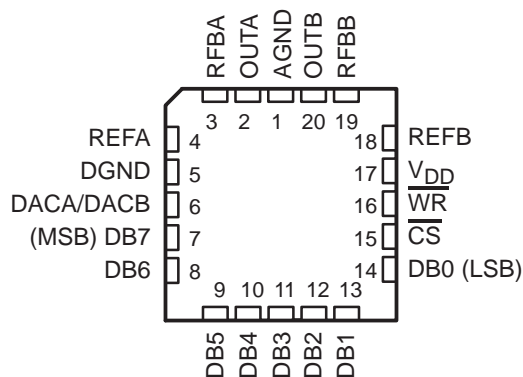
These devices operate from a 5V to 15V power supply and dissipates less than 15mW (typical). The 2- or 4-quadrant multiplying makes these devices a sound choice for many microprocessor-controlled gain-setting and signal-control applications. It can be operated in voltage mode, which produces a voltage output rather than a current output. Refer to the typical application information in this data sheet.

The TLC7528C is characterized for operation from 0°C to +70°C. The TLC7528I is characterized for operation from –25°C to +85°C. The TLC7528E is characterized for operation from –40°C to +85°C.

DW, N OR PW PACKAGE
(TOP VIEW)



FN PACKAGE
(TOP VIEW)



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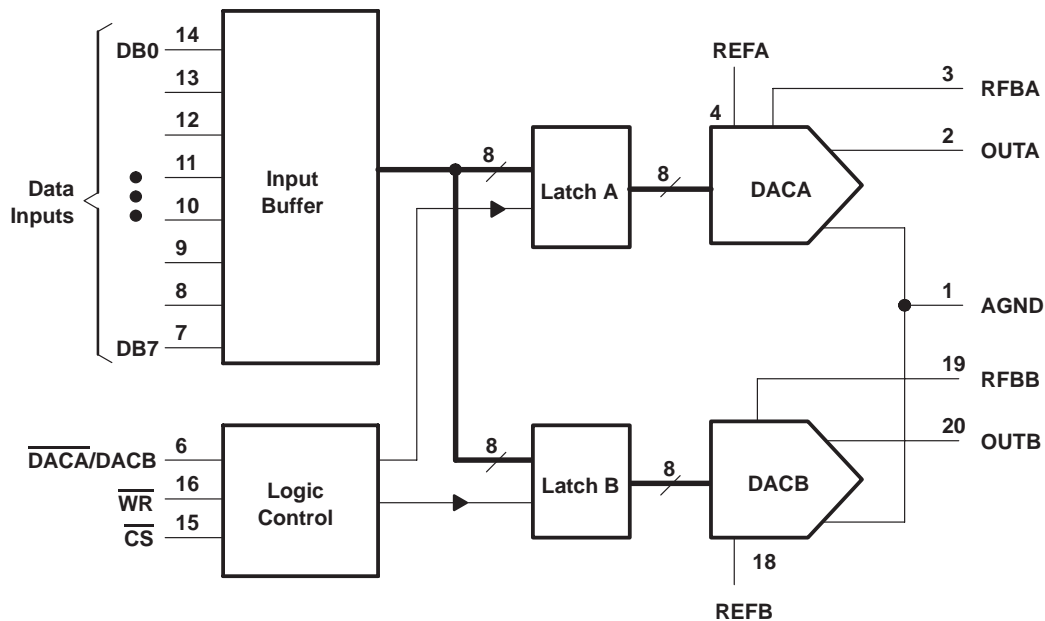
TLC7528C, TLC7528E, TLC7528I

DUAL 8-BIT MULTIPLYING

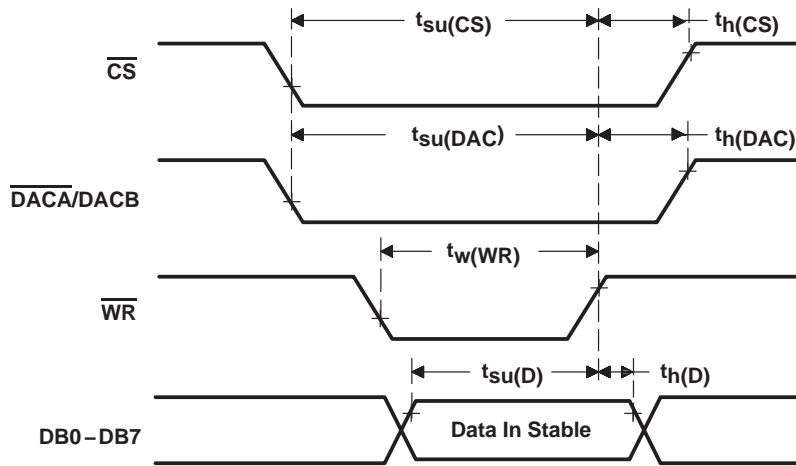
DIGITAL-TO-ANALOG CONVERTERS

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functional block diagram



operating sequence



absolute maximum ratings over operating free-air temperature range (unless otherwise noted)†

| | |
|--|-------------------------|
| Supply voltage range, V_{DD} (to AGND or DGND) | –0.3V to 16.5V |
| Voltage between AGND and DGND | $\pm V_{DD}$ |
| Input voltage range, V_I (to DGND) | –0.3V to $V_{DD} + 0.3$ |
| Reference voltage, V_{refA} or V_{refB} (to AGND) | $\pm 25V$ |
| Feedback voltage V_{RFBA} or V_{RFBB} (to AGND) | $\pm 25V$ |
| Input voltage (voltage mode out A, out B to AGND) | –0.3V to $V_{DD} + 0.3$ |
| Output voltage, V_{OA} or V_{OB} (to AGND) | $\pm 25V$ |
| Peak input current | 10 μ A |
| Operating free-air temperature range, T_A : | |
| TLC7528C | 0°C to +70°C |
| TLC7528I | –25°C to +85°C |
| TLC7528E | –40°C to +85°C |
| Storage temperature range, T_{stg} | –65°C to +150°C |
| Case temperature for 10 seconds, T_C : FN package | +260°C |
| Lead temperature 1,6mm (1/16 inch) from case for 10 seconds: DW or N package | +260°C |

† Stresses beyond those listed under “absolute maximum ratings” may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under “recommended operating conditions” is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

package/ordering information

For the most current package and ordering information, see the Package Option Addendum at the end of this document, or see the TI website at www.ti.com.

recommended operating conditions

| | $V_{DD} = 4.75V \text{ to } 5.25V$ | | | $V_{DD} = 14.5V \text{ to } 15.5V$ | | | UNIT |
|--|------------------------------------|-----|-----|------------------------------------|-----|-----|------|
| | MIN | NOM | MAX | MIN | NOM | MAX | |
| Reference voltage, V_{refA} or V_{refB} | ± 10 | | | ± 10 | | | V |
| High-level input voltage, V_{IH} | 2.4 | | | 13.5 | | | V |
| Low-level input voltage, V_{IL} | 0.8 | | | 1.5 | | | V |
| \overline{CS} setup time, $t_{su}(CS)$ | 50 | | | 50 | | | ns |
| \overline{CS} hold time, $t_h(CS)$ | 0 | | | 0 | | | ns |
| DAC select setup time, $t_{su}(DAC)$ | 50 | | | 50 | | | ns |
| DAC select hold time, $t_h(DAC)$ | 10 | | | 10 | | | ns |
| Data bus input setup time $t_{su}(D)$ | 25 | | | 25 | | | ns |
| Data bus input hold time $t_h(D)$ | 10 | | | 10 | | | ns |
| Pulse duration, \overline{WR} low, $t_w(WR)$ | 50 | | | 50 | | | ns |
| Operating free-air temperature, T_A | TLC7628C | 0 | +70 | 0 | +70 | | °C |
| | TLC7628I | –25 | +85 | –25 | +85 | | |
| | TLC7628E | –40 | +85 | –40 | +85 | | |

TLC7528C, TLC7528E, TLC7528I
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electrical characteristics over recommended operating free-air temperature range,
 $V_{refA} = V_{refB} = 10V$, V_{OA} and V_{OB} at 0V (unless otherwise noted)

| PARAMETER | | TEST CONDITIONS | $V_{DD} = 5V$ | | | $V_{DD} = 15V$ | | | UNIT |
|--|---------------------------------|--|---------------|------|-----------|----------------|------|-----------|-----------|
| | | | MIN | TYP† | MAX | MIN | TYP† | MAX | |
| I_{IH} | High-level input current | $V_I = V_{DD}$ | | | 10 | | | 10 | μA |
| I_{IL} | Low-level input current | $V_I = 0$ | 5 | 12 | -10 | 5 | 12 | -10 | μA |
| Reference input impedance REFA or REFB to AGND | | | | | 20 | | | 20 | $k\Omega$ |
| I_{Ikg} | Output leakage current | OUTA DAC data latch loaded with 00000000, $V_{refA} = \pm 10V$ | | | ± 400 | | | ± 200 | nA |
| | | OUTB DAC data latch loaded with 00000000, $V_{refB} = \pm 10V$ | | | ± 400 | | | ± 200 | |
| Input resistance match (REFA to REFB) | | | | | $\pm 1\%$ | | | $\pm 1\%$ | |
| DC supply sensitivity, $\Delta gain/\Delta V_{DD}$ | | $\Delta V_{DD} = \pm 10\%$ | | | 0.04 | | | 0.02 | %/% |
| I_{DD} | Supply current (quiescent) | All digital inputs at V_{IHmin} or V_{ILmax} | | | 2 | | | 2 | mA |
| I_{DD} | Supply current (standby) | All digital inputs at 0V or V_{DD} | | | 0.5 | | | 0.5 | mA |
| C_i | Input capacitance | DB0–DB7 | | | 10 | | | 10 | pF |
| | | \overline{WR} , \overline{CS} , DACA/DACB | | | 15 | | | 15 | pF |
| C_o | Output capacitance (OUTA, OUTB) | DAC data latches loaded with 00000000 | | | 50 | | | 50 | pF |
| | | DAC data latches loaded with 11111111 | | | 120 | | | 120 | |

† All typical values are at $T_A = +25^\circ C$.



operating characteristics over recommended operating free-air temperature range,
 $V_{refA} = V_{refB} = 10V$, V_{OA} and V_{OB} at 0V (unless otherwise noted)

| PARAMETER | | TEST CONDITIONS | $V_{DD} = 5V$ | | | $V_{DD} = 15V$ | | | UNIT |
|--|--------------|---|---------------|-----|-------|----------------|-----|--------|---------|
| | | | MIN | TYP | MAX | MIN | TYP | MAX | |
| Linearity error | | | | | ±1/2 | | | ±1/2 | LSB |
| Settling time (to 1/2LSB) | | See Note 1 | | | 100 | | | 100 | ns |
| Gain error | | See Note 2 | | | 2.5 | | | 2.5 | LSB |
| AC feedthrough | REFA to OUTA | See Note 3 | | | -65 | | | -65 | dB |
| | REFB to OUTB | | | | -65 | | | -65 | |
| Temperature coefficient of gain | | See Note 4 | | | 0.007 | | | 0.0035 | %FSR/°C |
| Propagation delay (from digital input to 90% of final analog output current) | | See Note 5 | | | 80 | | | 80 | ns |
| Channel-to-channel isolation | REFA to OUTB | See Note 6 | | | 77 | | | 77 | dB |
| | REFB to OUTA | See Note 7 | | | 77 | | | 77 | |
| Digital-to-analog glitch impulse area | | Measured for code transition from 00000000 to 11111111, $T_A = +25^\circ C$ | | | 160 | | | 440 | nV-s |
| Digital crosstalk | | Measured for code transition from 00000000 to 11111111, $T_A = +25^\circ C$ | | | 30 | | | 60 | nV-s |
| Harmonic distortion | | $V_i = 6V$, $f = 1kHz$, $T_A = +25^\circ C$ | | | -85 | | | -85 | dB |

- NOTES:
1. OUTA, OUTB load = 100Ω, $C_{ext} = 13pF$; \overline{WR} and \overline{CS} at 0V; DB0-DB7 at 0V to V_{DD} or V_{DD} to 0V.
 2. Gain error is measured using an internal feedback resistor. Nominal full scale range (FSR) = $V_{ref} - 1LSB$.
 3. $V_{ref} = 20V$ peak-to-peak, 100kHz sine wave; DAC data latches loaded with 00000000.
 4. Temperature coefficient of gain measured from 0°C to +25°C or from +25°C to +70°C.
 5. $V_{refA} = V_{refB} = 10V$; OUTA/OUTB load = 100Ω, $C_{ext} = 13pF$; \overline{WR} and \overline{CS} at 0V; DB0-DB7 at 0V to V_{DD} or V_{DD} to 0V.
 6. Both DAC latches loaded with 11111111; $V_{refA} = 20V$ peak-to-peak, 100kHz sine wave; $V_{refB} = 0$; $T_A = +25^\circ C$.
 7. Both DAC latches loaded with 11111111; $V_{refB} = 20V$ peak-to-peak, 100kHz sine wave; $V_{refA} = 0$; $T_A = +25^\circ C$.

PRINCIPLES OF OPERATION

These devices contain two identical, 8-bit-multiplying DACs, DACA and DACB. Each DAC consists of an inverted R-2R ladder, analog switches, and input data latches. Binary-weighted currents are switched between DAC output and AGND, thus maintaining a constant current in each ladder leg independent of the switch state. Most applications require only the addition of an external operational amplifier and voltage reference. A simplified DAC circuit for DACA with all digital inputs low is shown in Figure 1.

Figure 2 shows the DACA equivalent circuit. A similar equivalent circuit can be drawn for DACB. Both DACs share the analog ground terminal 1 (AGND). With all digital inputs high, the entire reference current flows to OUTA. A small leakage current (I_{lkg}) flows across internal junctions, and as with most semiconductor devices, doubles every 10°C. C_o is due to the parallel combination of the NMOS switches and has a value that depends on the number of switches connected to the output. The range of C_o is 50pF to 120pF maximum. The equivalent output resistance (r_o) varies with the input code from 0.8R to 3R where R is the nominal value of the ladder resistor in the R-2R network.

These devices interface to a microprocessor through the data bus, \overline{CS} , \overline{WR} , and $\overline{DACA/DACB}$ control signals. When \overline{CS} and \overline{WR} are both low, the TLC7528 analog output, specified by the $\overline{DACA/DACB}$ control line, responds to the activity on the DB0-DB7 data bus inputs. In this mode, the input latches are transparent and input data directly affects the analog output. When either the \overline{CS} signal or \overline{WR} signal goes high, the data on the DB0-DB7 inputs are latched until the \overline{CS} and \overline{WR} signals go low again. When \overline{CS} is high, the data inputs are disabled regardless of the state of the \overline{WR} signal.

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PRINCIPLES OF OPERATION

The digital inputs of these devices provide TTL compatibility when operated from a supply voltage of 5V. These devices can operate with any supply voltage in the range from 5V to 15V; however, input logic levels are not TTL-compatible above 5V.

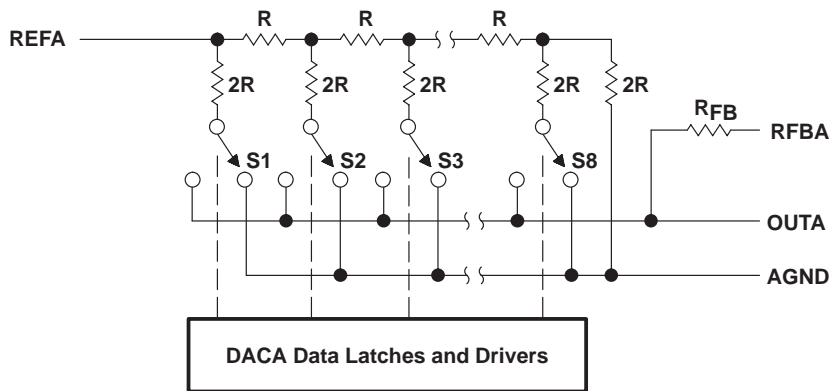


Figure 1. Simplified Functional Circuit for DACA

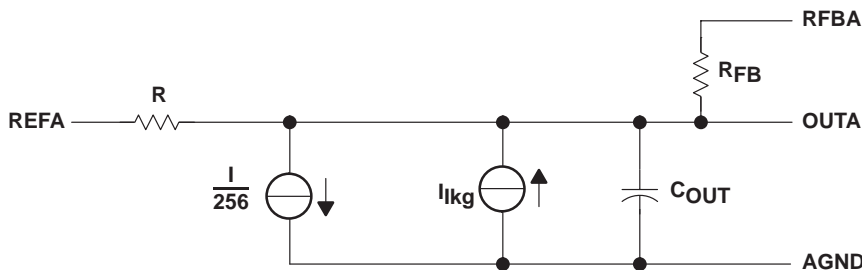


Figure 2. TLC7528 Equivalent Circuit, DACA Latch Loaded With 11111111

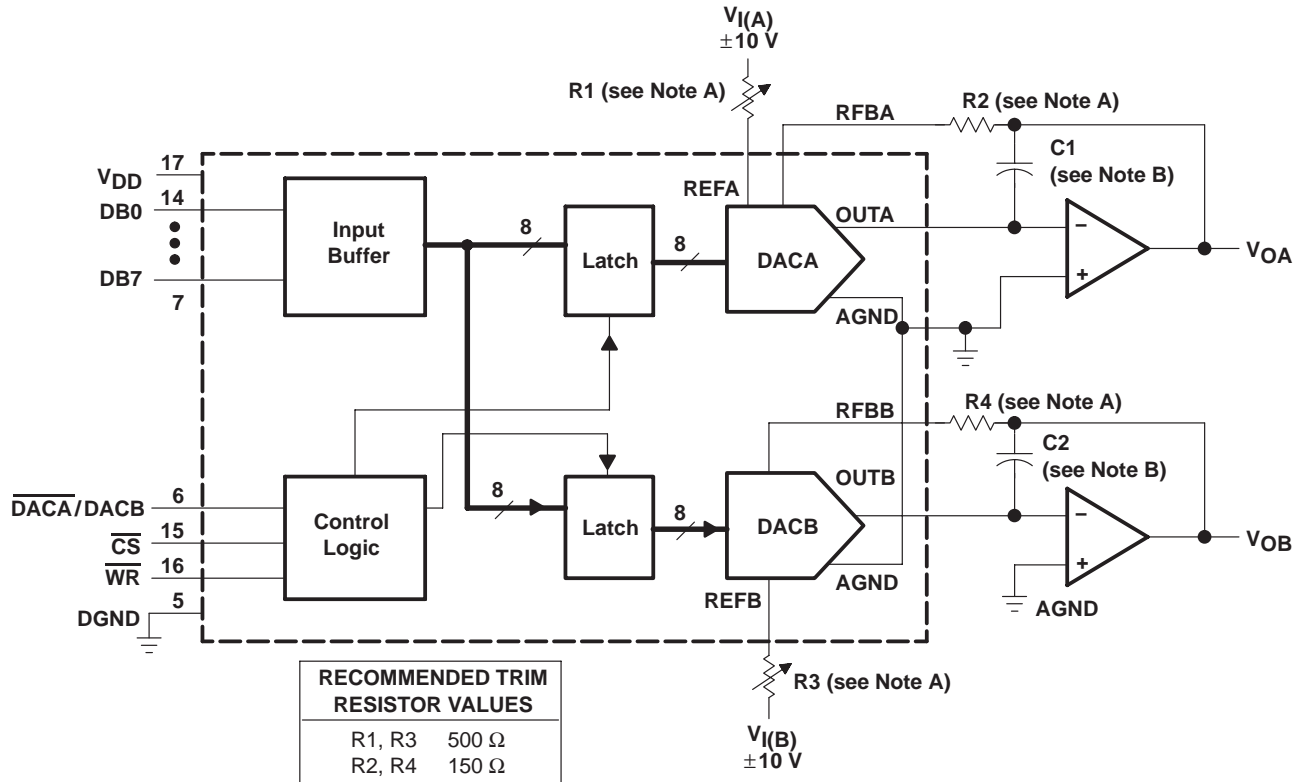
MODE SELECTION TABLE

| DACA/DACB | \overline{CS} | \overline{WR} | DACA | DACB |
|-----------|-----------------|-----------------|-------|-------|
| L | L | L | Write | Hold |
| H | L | L | Hold | Write |
| X | H | X | Hold | Hold |
| X | X | H | Hold | Hold |

L = low level, H = high level, X = don't care

APPLICATION INFORMATION

These devices are capable of performing 2-quadrant or full 4-quadrant multiplication. Circuit configurations for 2-quadrant and 4-quadrant multiplication are shown in Figure 3 and Figure 4. Table 1 and Table 2 summarize input coding for unipolar and bipolar operation, respectively.



- NOTES: A. R1, R2, R3, and R4 are used only if gain adjustment is required. See table for recommended values. Make gain adjustment with digital input of 255.
 B. C1 and C2 phase compensation capacitors (10pF to 15pF) are required when using high-speed amplifiers to prevent ringing or oscillation.

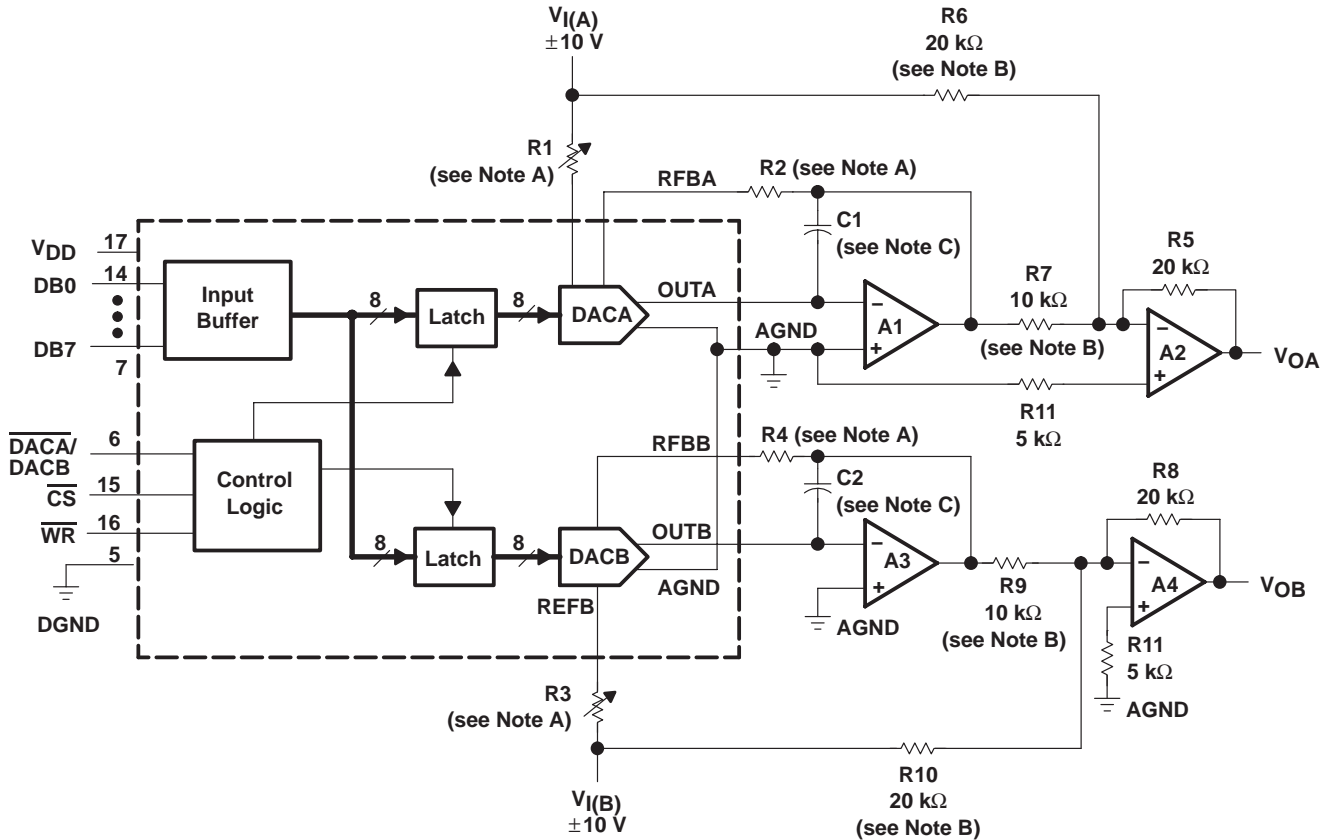
Figure 3. Unipolar Operation (2-Quadrant Multiplication)

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APPLICATION INFORMATION



- NOTES: A. R1, R2, R3, and R4 are used only if gain adjustment is required. See table in Figure 3 for recommended values. Adjust R1 for $V_{OA} = 0V$ with code 10000000 in DACA latch. Adjust R3 for $V_{OB} = 0V$ with 10000000 in DACB latch.
- B. Matching and tracking are essential for resistor pairs R6, R7, R9, and R10.
- C. C1 and C2 phase compensation capacitors (10pF to 15pF) may be required if A1 and A3 are high-speed amplifiers.

Figure 4. Bipolar Operation (4-Quadrant Operation)

Table 1. Unipolar Binary Code

| DAC LATCH CONTENTS | | ANALOG OUTPUT |
|--------------------|---------|---------------------------|
| MSB | LSB† | |
| 1 | 1111111 | $-V_I (255/256)$ |
| 1 | 0000001 | $-V_I (129/256)$ |
| 1 | 0000000 | $-V_I (128/256) = -V_I/2$ |
| 0 | 1111111 | $-V_I (127/256)$ |
| 0 | 0000001 | $-V_I (1/256)$ |
| 0 | 0000000 | $-V_I (0/256) = 0$ |

† 1LSB = $(2^{-8})V_I$

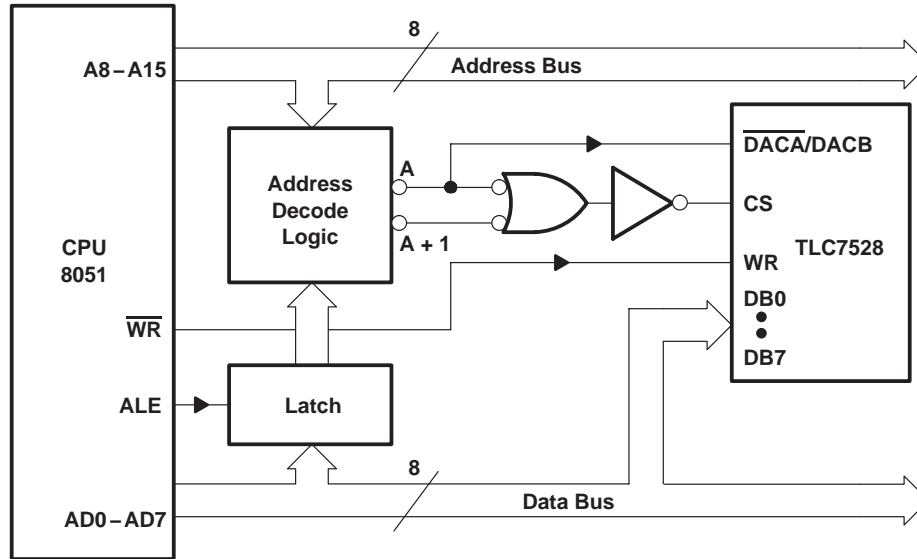
Table 2. Bipolar (Offset Binary) Code

| DAC LATCH CONTENTS | | ANALOG OUTPUT |
|--------------------|---------|------------------|
| MSB | LSB‡ | |
| 1 | 1111111 | $V_I (127/128)$ |
| 1 | 0000001 | $V_I (1/128)$ |
| 1 | 0000000 | 0V |
| 0 | 1111111 | $-V_I (1/128)$ |
| 0 | 0000001 | $-V_I (127/128)$ |
| 0 | 0000000 | $-V_I (128/128)$ |

‡ 1LSB = $(2^{-7})V_I$

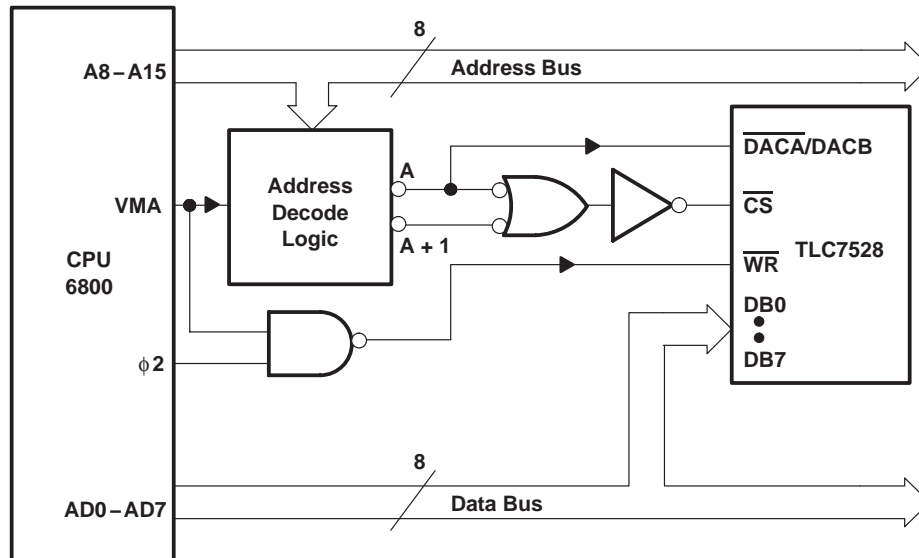
APPLICATION INFORMATION

microprocessor interface information



NOTE A: A = decoded address for TLC7528 DACA
 A + 1 = decoded address for TLC7528 DACB

Figure 5. TLC7528: Intel 8051 Interface



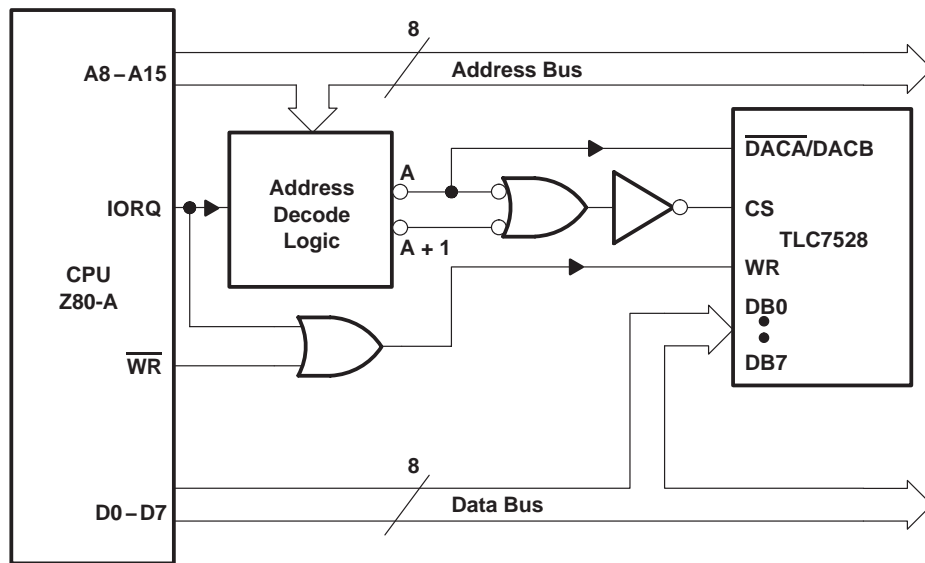
NOTE A: A = decoded address for TLC7528 DACA
 A + 1 = decoded address for TLC7528 DACB

Figure 6. TLC7528: 6800 Interface

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APPLICATION INFORMATION



NOTE A: A = decoded address for TLC7528 DACA
 A + 1 = decoded address for TLC7528 DACB

Figure 7. TLC7528 To Z-80A Interface

programmable window detector

The programmable window comparator shown in Figure 8 determines if the voltage applied to the DAC feedback resistors is within the limits programmed into the data latches of these devices. Input signal range depends on the reference and polarity; that is, the test input range is 0 to $-V_{ref}$. The DACA and DACB data latches are programmed with the upper and lower test limits. A signal within the programmed limits drives the output high.

APPLICATION INFORMATION

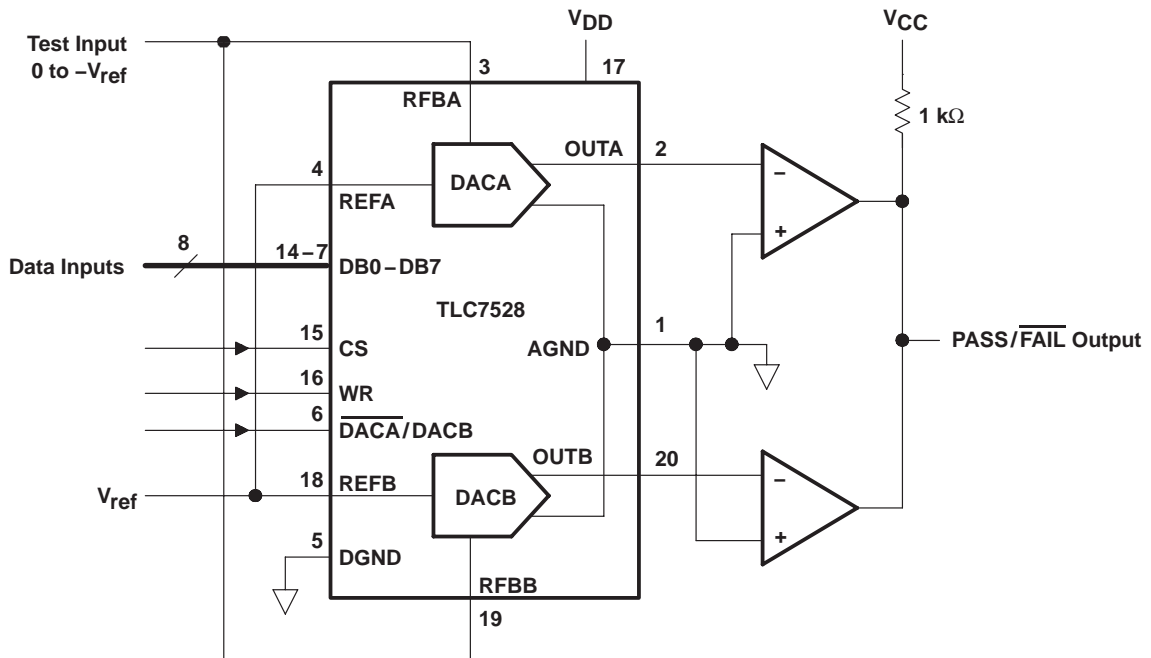


Figure 8. Digitally-Programmable Window Comparator (Upper- and Lower-Limit Tester)

digitally-controlled signal attenuator

Figure 9 shows a TLC7528 configured as a two-channel programmable attenuator. Applications include stereo audio and telephone signal level control. Table 3 shows input codes vs attenuation for a 0dB to 15.5dB range.

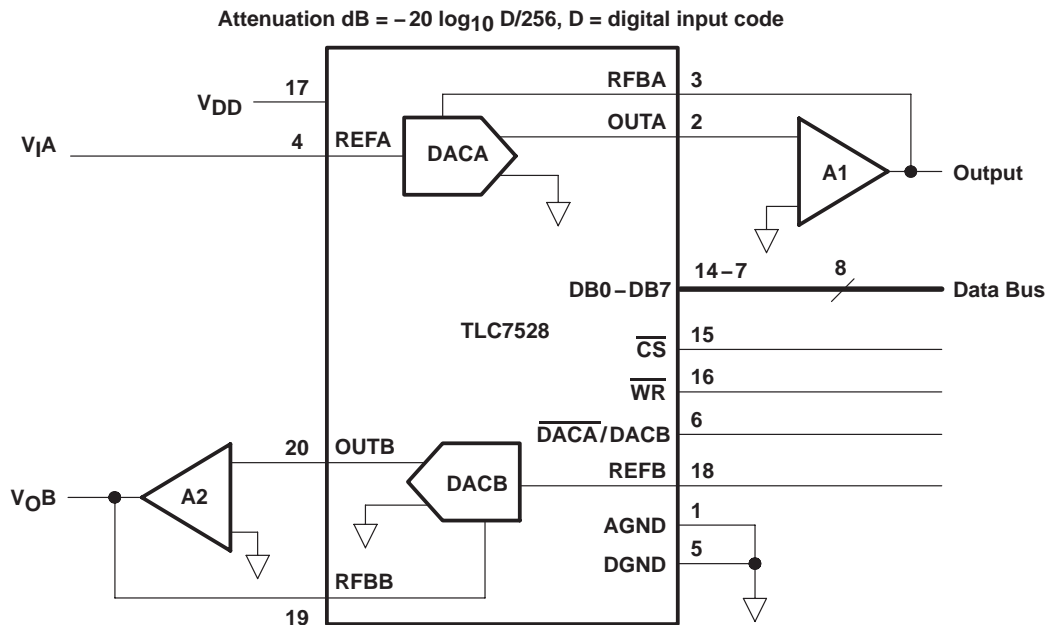


Figure 9. Digitally Controlled Dual Telephone Attenuator

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APPLICATION INFORMATION

Table 3. Attenuation vs DACA, DACB Code

| ATTEN (dB) | DAC INPUT CODE | CODE IN DECIMAL | ATTN (dB) | DAC INPUT CODE | CODE IN DECIMAL |
|------------|-----------------|-----------------|-----------|-----------------|-----------------|
| 0 | 1 1 1 1 1 1 1 1 | 255 | 8.0 | 0 1 1 0 0 1 1 0 | 102 |
| 0.5 | 1 1 1 1 0 0 1 0 | 242 | 8.5 | 0 1 1 0 0 0 0 0 | 96 |
| 1.0 | 1 1 1 0 0 1 0 0 | 228 | 9.0 | 0 1 0 1 1 0 1 1 | 91 |
| 1.5 | 1 1 0 1 0 1 1 1 | 215 | 9.5 | 0 1 0 1 0 1 1 0 | 86 |
| 2.0 | 1 1 0 0 1 0 1 1 | 203 | 10.0 | 0 1 0 1 0 0 0 1 | 81 |
| 2.5 | 1 1 0 0 0 0 0 0 | 192 | 10.5 | 0 1 0 0 1 1 0 0 | 76 |
| 3.0 | 1 0 1 1 0 1 0 1 | 181 | 11.0 | 0 1 0 0 1 0 0 0 | 72 |
| 3.5 | 1 0 1 0 1 0 1 1 | 171 | 11.5 | 0 1 0 0 0 1 0 0 | 68 |
| 4.0 | 1 0 1 0 0 0 1 0 | 162 | 12.0 | 0 1 0 0 0 0 0 0 | 64 |
| 4.5 | 1 0 0 1 1 0 0 0 | 152 | 12.5 | 0 0 1 1 1 1 0 1 | 61 |
| 5.0 | 1 0 0 1 1 1 1 1 | 144 | 13.0 | 0 0 1 1 1 0 0 1 | 57 |
| 5.5 | 1 0 0 0 1 0 0 0 | 136 | 13.5 | 0 0 1 1 0 1 1 0 | 54 |
| 6.0 | 1 0 0 0 0 0 0 0 | 128 | 14.0 | 0 0 1 1 0 0 1 1 | 51 |
| 6.5 | 0 1 1 1 1 0 0 1 | 121 | 14.5 | 0 0 1 1 0 0 0 0 | 48 |
| 7.0 | 0 1 1 1 0 0 1 0 | 114 | 15.0 | 0 0 1 0 1 1 1 0 | 46 |
| 7.5 | 0 1 1 0 1 1 0 0 | 108 | 15.5 | 0 0 1 0 1 0 1 1 | 43 |

programmable state-variable filter

This programmable state-variable or universal filter configuration provides low-pass, high-pass, and bandpass outputs, and is suitable for applications requiring microprocessor control of filter parameters.

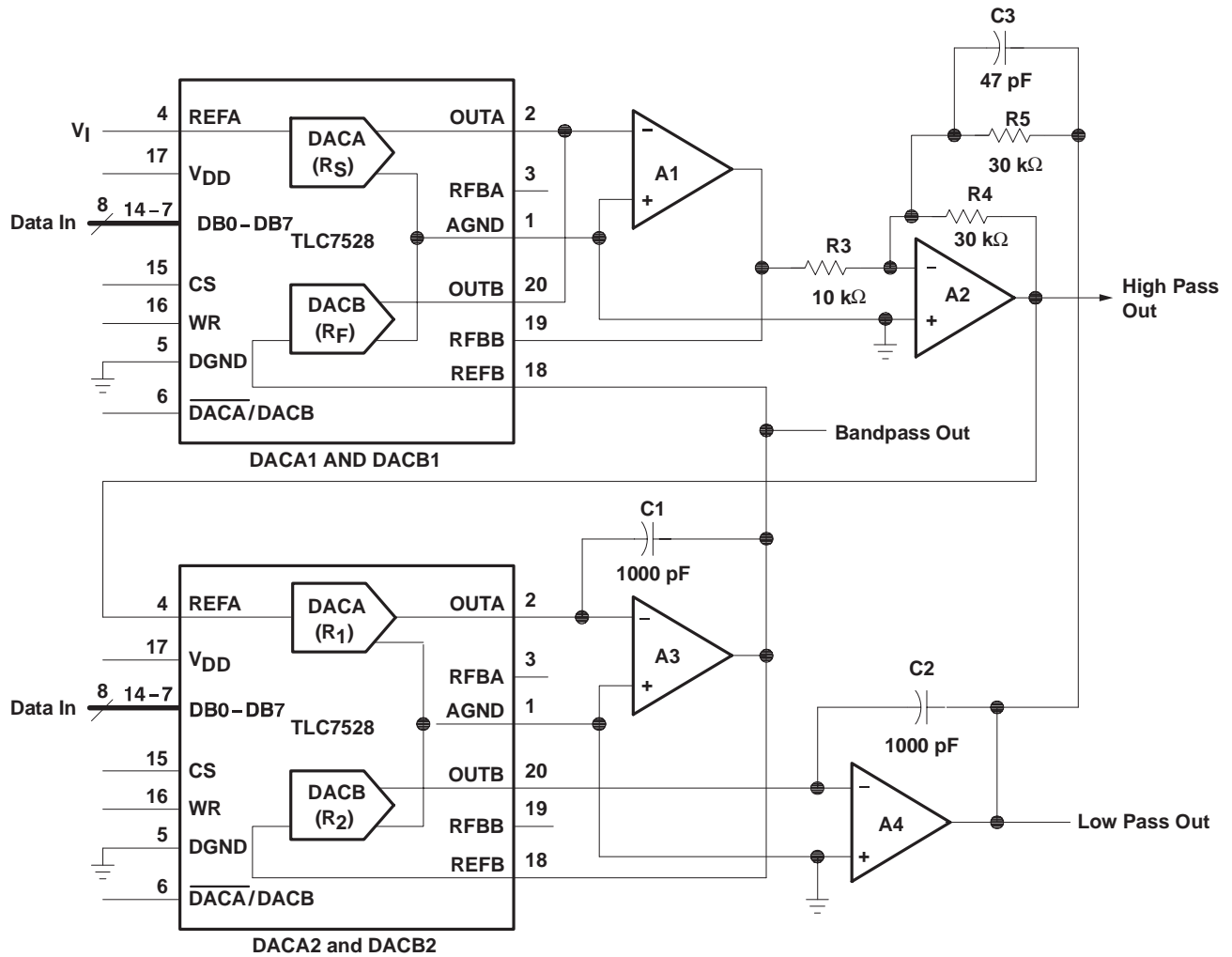
As shown in Figure 10, DACA1 and DACB1 control the gain and Q of the filter while DACA2 and DACB2 control the cutoff frequency. Both halves of the DACA2 and DACB2 must track accurately in order for the cutoff-frequency equation to be true. With the TLC7528, this validity is easy to achieve.

$$f_c = \frac{1}{2\pi R1C1}$$

The programmable range for the cutoff or center frequency is 0kHz to 15kHz with a Q ranging from 0.3 to 4.5. This parameter defines the limits of the component values.



APPLICATION INFORMATION



Circuit Equations:

$$C_1 = C_2, R_1 = R_2, R_4 = R_5$$

$$Q = \frac{R_3}{R_4} \times \frac{R_F}{R_{fb}(\text{DACB1})}$$

Where:

R_{fb} is the internal resistor connected between OUTB and RFBB

$$G = -\frac{R_F}{R_S}$$

- NOTES: A. Op-amps A1, A2, A3, and A4 are TL287.
 B. CS compensates for the op-amp gain-bandwidth limitations.
 C. DAC equivalent resistance equals $\frac{256 \times (\text{DAC ladder resistance})}{\text{DAC digital code}}$

Figure 10. Digitally-Controlled State-Variable Filter

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APPLICATION INFORMATION

voltage-mode operation

It is possible to operate the current multiplying D/A converter of these devices in a voltage mode. In the voltage mode, a fixed voltage is placed on the current output terminal. The analog output voltage is then available at the reference voltage terminal. Figure 11 is an example of a current multiplying D/A that operates in the voltage mode.

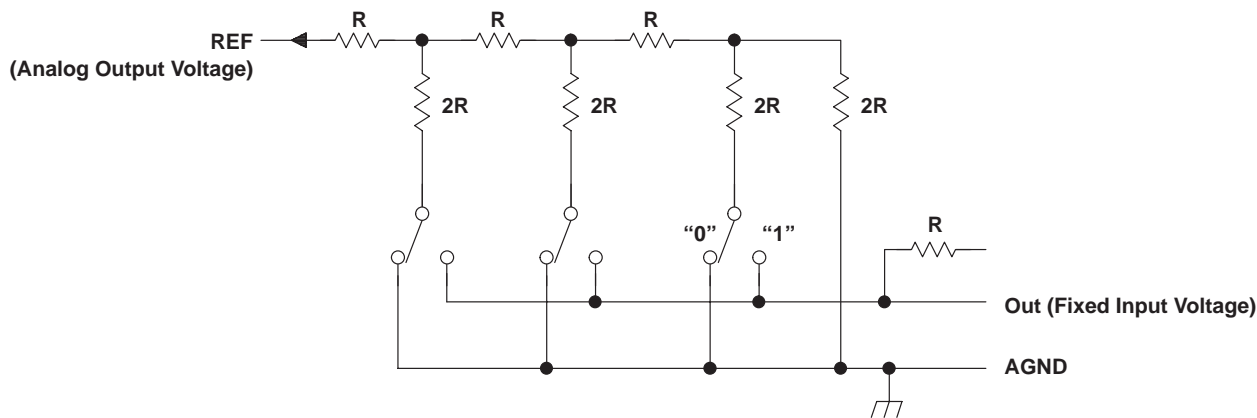


Figure 11. Voltage-Mode Operation

The following equation shows the relationship between the fixed input voltage and the analog output voltage:

$$V_O = V_I (D/256)$$

Where:

- V_O = analog output voltage
- V_I = fixed input voltage (must not be forced below 0V.)
- D = digital input code converted to decimal

In voltage-mode operation, these devices meet the following specification:

| PARAMETER | TEST CONDITIONS | MIN | MAX | UNIT |
|---------------------------------|---|-----|-----|------|
| Linearity error at REFA or REFB | $V_{DD} = 5V$, $OUTA$ or $OUTB$ at 2.5V, $T_A = +25^\circ C$ | | 1 | LSB |

Revision History

| DATE | REV | PAGE | SECTION | DESCRIPTION |
|-------|-----|------------|-------------------------|--|
| 11/08 | E | 13 | Application Information | Corrected Figure 10. |
| 6/07 | D | Front Page | — | Deleted Available Options table. |
| | | 3 | — | Inserted Package/Ordering information. |

NOTE: Page numbers for previous revisions may differ from page numbers in the current version.

PACKAGING INFORMATION

| Orderable part number | Status (1) | Material type (2) | Package Pins | Package qty Carrier | RoHS (3) | Lead finish/ Ball material (4) | MSL rating/ Peak reflow (5) | Op temp (°C) | Part marking (6) |
|-----------------------------|---------------|----------------------|-----------------|-----------------------|-------------|--------------------------------------|-----------------------------------|--------------|---------------------|
| TLC7528CDW | Active | Production | SOIC (DW) 20 | 25 TUBE | Yes | NIPDAU | Level-1-260C-UNLIM | 0 to 70 | TLC7528C |
| TLC7528CDW.A | Active | Production | SOIC (DW) 20 | 25 TUBE | Yes | NIPDAU | Level-1-260C-UNLIM | 0 to 70 | TLC7528C |
| TLC7528CDWR | Active | Production | SOIC (DW) 20 | 2000 LARGE T&R | Yes | NIPDAU | Level-1-260C-UNLIM | 0 to 70 | TLC7528C |
| TLC7528CDWR.A | Active | Production | SOIC (DW) 20 | 2000 LARGE T&R | Yes | NIPDAU | Level-1-260C-UNLIM | 0 to 70 | TLC7528C |
| TLC7528CDWRG4 | Active | Production | SOIC (DW) 20 | 2000 LARGE T&R | Yes | NIPDAU | Level-1-260C-UNLIM | 0 to 70 | TLC7528C |
| TLC7528CFN | Obsolete | Production | PLCC (FN) 20 | - | - | Call TI | Call TI | 0 to 70 | TLC7528C |
| TLC7528CFNR | Obsolete | Production | PLCC (FN) 20 | - | - | Call TI | Call TI | 0 to 70 | TLC7528C |
| TLC7528CN | Active | Production | PDIP (N) 20 | 20 TUBE | Yes | NIPDAU | N/A for Pkg Type | 0 to 70 | TLC7528CN |
| TLC7528CN.A | Active | Production | PDIP (N) 20 | 20 TUBE | Yes | NIPDAU | N/A for Pkg Type | 0 to 70 | TLC7528CN |
| TLC7528CNS | Active | Production | SOP (NS) 20 | 40 TUBE | Yes | NIPDAU | Level-1-260C-UNLIM | 0 to 70 | TLC7528 |
| TLC7528CNS.A | Active | Production | SOP (NS) 20 | 40 TUBE | Yes | NIPDAU | Level-1-260C-UNLIM | 0 to 70 | TLC7528 |
| TLC7528CNSR | Active | Production | SOP (NS) 20 | 2000 LARGE T&R | Yes | NIPDAU | Level-1-260C-UNLIM | 0 to 70 | TLC7528 |
| TLC7528CNSR.A | Active | Production | SOP (NS) 20 | 2000 LARGE T&R | Yes | NIPDAU | Level-1-260C-UNLIM | 0 to 70 | TLC7528 |
| TLC7528CPW | Active | Production | TSSOP (PW) 20 | 70 TUBE | Yes | NIPDAU | Level-1-260C-UNLIM | 0 to 70 | TLC7528C |
| TLC7528CPW.A | Active | Production | TSSOP (PW) 20 | 70 TUBE | Yes | NIPDAU | Level-1-260C-UNLIM | 0 to 70 | TLC7528C |
| TLC7528CPWR | Active | Production | TSSOP (PW) 20 | 2000 LARGE T&R | Yes | NIPDAU | Level-1-260C-UNLIM | 0 to 70 | TLC7528C |
| TLC7528CPWR.A | Active | Production | TSSOP (PW) 20 | 2000 LARGE T&R | Yes | NIPDAU | Level-1-260C-UNLIM | 0 to 70 | TLC7528C |
| TLC7528EDW | Active | Production | SOIC (DW) 20 | 25 TUBE | Yes | NIPDAU | Level-1-260C-UNLIM | -40 to 85 | TLC7528E |
| TLC7528EDW.A | Active | Production | SOIC (DW) 20 | 25 TUBE | Yes | NIPDAU | Level-1-260C-UNLIM | -40 to 85 | TLC7528E |
| TLC7528EDWG4 | Active | Production | SOIC (DW) 20 | 25 TUBE | Yes | NIPDAU | Level-1-260C-UNLIM | -40 to 85 | TLC7528E |
| TLC7528EDWR | Active | Production | SOIC (DW) 20 | 2000 LARGE T&R | Yes | NIPDAU | Level-1-260C-UNLIM | -40 to 85 | TLC7528E |
| TLC7528EDWR.A | Active | Production | SOIC (DW) 20 | 2000 LARGE T&R | Yes | NIPDAU | Level-1-260C-UNLIM | -40 to 85 | TLC7528E |
| TLC7528EN | Active | Production | PDIP (N) 20 | 20 TUBE | Yes | NIPDAU | N/A for Pkg Type | -40 to 85 | TLC7528EN |
| TLC7528EN.A | Active | Production | PDIP (N) 20 | 20 TUBE | Yes | NIPDAU | N/A for Pkg Type | -40 to 85 | TLC7528EN |
| TLC7528IDW | Active | Production | SOIC (DW) 20 | 25 TUBE | Yes | NIPDAU | Level-1-260C-UNLIM | -25 to 85 | TLC7528I |
| TLC7528IDW.A | Active | Production | SOIC (DW) 20 | 25 TUBE | Yes | NIPDAU | Level-1-260C-UNLIM | -25 to 85 | TLC7528I |
| TLC7528IDWR | Active | Production | SOIC (DW) 20 | 2000 LARGE T&R | Yes | NIPDAU | Level-1-260C-UNLIM | -25 to 85 | TLC7528I |
| TLC7528IDWR.A | Active | Production | SOIC (DW) 20 | 2000 LARGE T&R | Yes | NIPDAU | Level-1-260C-UNLIM | -25 to 85 | TLC7528I |
| TLC7528IFN | Obsolete | Production | PLCC (FN) 20 | - | - | Call TI | Call TI | -25 to 85 | TLC7528I |

| Orderable part number | Status (1) | Material type (2) | Package Pins | Package qty Carrier | RoHS (3) | Lead finish/ Ball material (4) | MSL rating/ Peak reflow (5) | Op temp (°C) | Part marking (6) |
|-----------------------------|---------------|----------------------|-----------------|-----------------------|-------------|--------------------------------------|-----------------------------------|--------------|---------------------|
| TLC7528IN | Active | Production | PDIP (N) 20 | 20 TUBE | Yes | NIPDAU | N/A for Pkg Type | -25 to 85 | TLC7528IN |
| TLC7528IN.A | Active | Production | PDIP (N) 20 | 20 TUBE | Yes | NIPDAU | N/A for Pkg Type | -25 to 85 | TLC7528IN |
| TLC7528IPW | Active | Production | TSSOP (PW) 20 | 70 TUBE | Yes | NIPDAU | Level-1-260C-UNLIM | -25 to 85 | TLC7528I |
| TLC7528IPW.A | Active | Production | TSSOP (PW) 20 | 70 TUBE | Yes | NIPDAU | Level-1-260C-UNLIM | -25 to 85 | TLC7528I |
| TLC7528IPWR | Active | Production | TSSOP (PW) 20 | 2000 LARGE T&R | Yes | NIPDAU | Level-1-260C-UNLIM | -25 to 85 | TLC7528I |
| TLC7528IPWR.A | Active | Production | TSSOP (PW) 20 | 2000 LARGE T&R | Yes | NIPDAU | Level-1-260C-UNLIM | -25 to 85 | TLC7528I |

(1) **Status:** For more details on status, see our [product life cycle](#).

(2) **Material type:** When designated, preproduction parts are prototypes/experimental devices, and are not yet approved or released for full production. Testing and final process, including without limitation quality assurance, reliability performance testing, and/or process qualification, may not yet be complete, and this item is subject to further changes or possible discontinuation. If available for ordering, purchases will be subject to an additional waiver at checkout, and are intended for early internal evaluation purposes only. These items are sold without warranties of any kind.

(3) **RoHS values:** Yes, No, RoHS Exempt. See the [TI RoHS Statement](#) for additional information and value definition.

(4) **Lead finish/Ball material:** Parts may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

(5) **MSL rating/Peak reflow:** The moisture sensitivity level ratings and peak solder (reflow) temperatures. In the event that a part has multiple moisture sensitivity ratings, only the lowest level per JEDEC standards is shown. Refer to the shipping label for the actual reflow temperature that will be used to mount the part to the printed circuit board.

(6) **Part marking:** There may be an additional marking, which relates to the logo, the lot trace code information, or the environmental category of the part.

Multiple part markings will be inside parentheses. Only one part marking contained in parentheses and separated by a "~" will appear on a part. If a line is indented then it is a continuation of the previous line and the two combined represent the entire part marking for that device.

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TAPE AND REEL INFORMATION

QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE


*All dimensions are nominal

| Device | Package Type | Package Drawing | Pins | SPQ | Reel Diameter (mm) | Reel Width W1 (mm) | A0 (mm) | B0 (mm) | K0 (mm) | P1 (mm) | W (mm) | Pin1 Quadrant |
|-------------|--------------|-----------------|------|------|--------------------|--------------------|---------|---------|---------|---------|--------|---------------|
| TLC7528CDWR | SOIC | DW | 20 | 2000 | 330.0 | 24.4 | 10.8 | 13.3 | 2.7 | 12.0 | 24.0 | Q1 |
| TLC7528CNSR | SOP | NS | 20 | 2000 | 330.0 | 24.4 | 8.4 | 13.0 | 2.5 | 12.0 | 24.0 | Q1 |
| TLC7528CPWR | TSSOP | PW | 20 | 2000 | 330.0 | 16.4 | 6.95 | 7.0 | 1.4 | 8.0 | 16.0 | Q1 |
| TLC7528EDWR | SOIC | DW | 20 | 2000 | 330.0 | 24.4 | 10.8 | 13.3 | 2.7 | 12.0 | 24.0 | Q1 |
| TLC7528IDWR | SOIC | DW | 20 | 2000 | 330.0 | 24.4 | 10.8 | 13.3 | 2.7 | 12.0 | 24.0 | Q1 |
| TLC7528IPWR | TSSOP | PW | 20 | 2000 | 330.0 | 16.4 | 6.95 | 7.0 | 1.4 | 8.0 | 16.0 | Q1 |

TAPE AND REEL BOX DIMENSIONS


*All dimensions are nominal

| Device | Package Type | Package Drawing | Pins | SPQ | Length (mm) | Width (mm) | Height (mm) |
|-------------|--------------|-----------------|------|------|-------------|------------|-------------|
| TLC7528CDWR | SOIC | DW | 20 | 2000 | 356.0 | 356.0 | 45.0 |
| TLC7528CNSR | SOP | NS | 20 | 2000 | 356.0 | 356.0 | 45.0 |
| TLC7528CPWR | TSSOP | PW | 20 | 2000 | 353.0 | 353.0 | 32.0 |
| TLC7528EDWR | SOIC | DW | 20 | 2000 | 356.0 | 356.0 | 45.0 |
| TLC7528IDWR | SOIC | DW | 20 | 2000 | 356.0 | 356.0 | 45.0 |
| TLC7528IPWR | TSSOP | PW | 20 | 2000 | 353.0 | 353.0 | 32.0 |

TUBE


*All dimensions are nominal

| Device | Package Name | Package Type | Pins | SPQ | L (mm) | W (mm) | T (μm) | B (mm) |
|--------------|--------------|--------------|------|-----|--------|--------|--------|--------|
| TLC7528CDW | DW | SOIC | 20 | 25 | 507 | 12.83 | 5080 | 6.6 |
| TLC7528CDW.A | DW | SOIC | 20 | 25 | 507 | 12.83 | 5080 | 6.6 |
| TLC7528CN | N | PDIP | 20 | 20 | 506 | 13.97 | 11230 | 4.32 |
| TLC7528CN.A | N | PDIP | 20 | 20 | 506 | 13.97 | 11230 | 4.32 |
| TLC7528CNS | NS | SOP | 20 | 40 | 530 | 10.5 | 4000 | 4.1 |
| TLC7528CNS.A | NS | SOP | 20 | 40 | 530 | 10.5 | 4000 | 4.1 |
| TLC7528CPW | PW | TSSOP | 20 | 70 | 530 | 10.2 | 3600 | 3.5 |
| TLC7528CPW.A | PW | TSSOP | 20 | 70 | 530 | 10.2 | 3600 | 3.5 |
| TLC7528EDW | DW | SOIC | 20 | 25 | 507 | 12.83 | 5080 | 6.6 |
| TLC7528EDW.A | DW | SOIC | 20 | 25 | 507 | 12.83 | 5080 | 6.6 |
| TLC7528EDWG4 | DW | SOIC | 20 | 25 | 507 | 12.83 | 5080 | 6.6 |
| TLC7528EN | N | PDIP | 20 | 20 | 506 | 13.97 | 11230 | 4.32 |
| TLC7528EN.A | N | PDIP | 20 | 20 | 506 | 13.97 | 11230 | 4.32 |
| TLC7528IDW | DW | SOIC | 20 | 25 | 507 | 12.83 | 5080 | 6.6 |
| TLC7528IDW.A | DW | SOIC | 20 | 25 | 507 | 12.83 | 5080 | 6.6 |
| TLC7528IN | N | PDIP | 20 | 20 | 506 | 13.97 | 11230 | 4.32 |
| TLC7528IN.A | N | PDIP | 20 | 20 | 506 | 13.97 | 11230 | 4.32 |
| TLC7528IPW | PW | TSSOP | 20 | 70 | 530 | 10.2 | 3600 | 3.5 |
| TLC7528IPW.A | PW | TSSOP | 20 | 70 | 530 | 10.2 | 3600 | 3.5 |



4220206/A 02/2017

NOTES:

1. All linear dimensions are in millimeters. Any dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
2. This drawing is subject to change without notice.
3. This dimension does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0.15 mm per side.
4. This dimension does not include interlead flash. Interlead flash shall not exceed 0.25 mm per side.
5. Reference JEDEC registration MO-153.

EXAMPLE BOARD LAYOUT

PW0020A

TSSOP - 1.2 mm max height

SMALL OUTLINE PACKAGE



LAND PATTERN EXAMPLE
EXPOSED METAL SHOWN
SCALE: 10X



SOLDER MASK DETAILS

4220206/A 02/2017

NOTES: (continued)

- 6. Publication IPC-7351 may have alternate designs.
- 7. Solder mask tolerances between and around signal pads can vary based on board fabrication site.

EXAMPLE STENCIL DESIGN

PW0020A

TSSOP - 1.2 mm max height

SMALL OUTLINE PACKAGE



SOLDER PASTE EXAMPLE
BASED ON 0.125 mm THICK STENCIL
SCALE: 10X

4220206/A 02/2017

NOTES: (continued)

8. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.
9. Board assembly site may have different recommendations for stencil design.

MECHANICAL DATA

NS (R-PDSO-G**)

PLASTIC SMALL-OUTLINE PACKAGE

14-PINS SHOWN



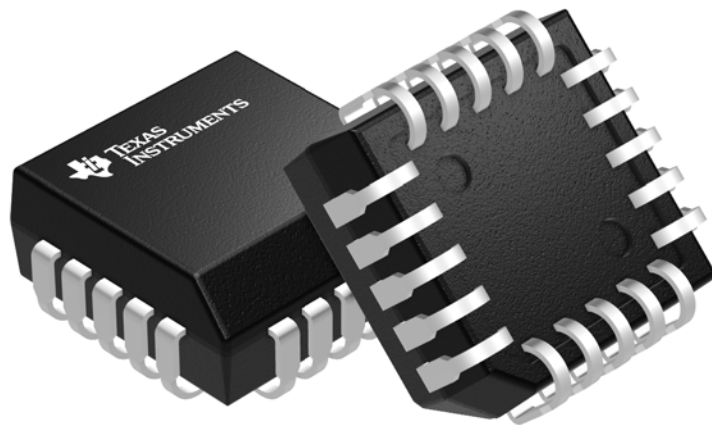
- NOTES:
- A. All linear dimensions are in millimeters.
 - B. This drawing is subject to change without notice.
 - C. Body dimensions do not include mold flash or protrusion, not to exceed 0,15.

FN 20

GENERIC PACKAGE VIEW

PLCC - 4.57 mm max height

PLASTIC CHIP CARRIER



Images above are just a representation of the package family, actual package may vary.
Refer to the product data sheet for package details.

4040005-2/C

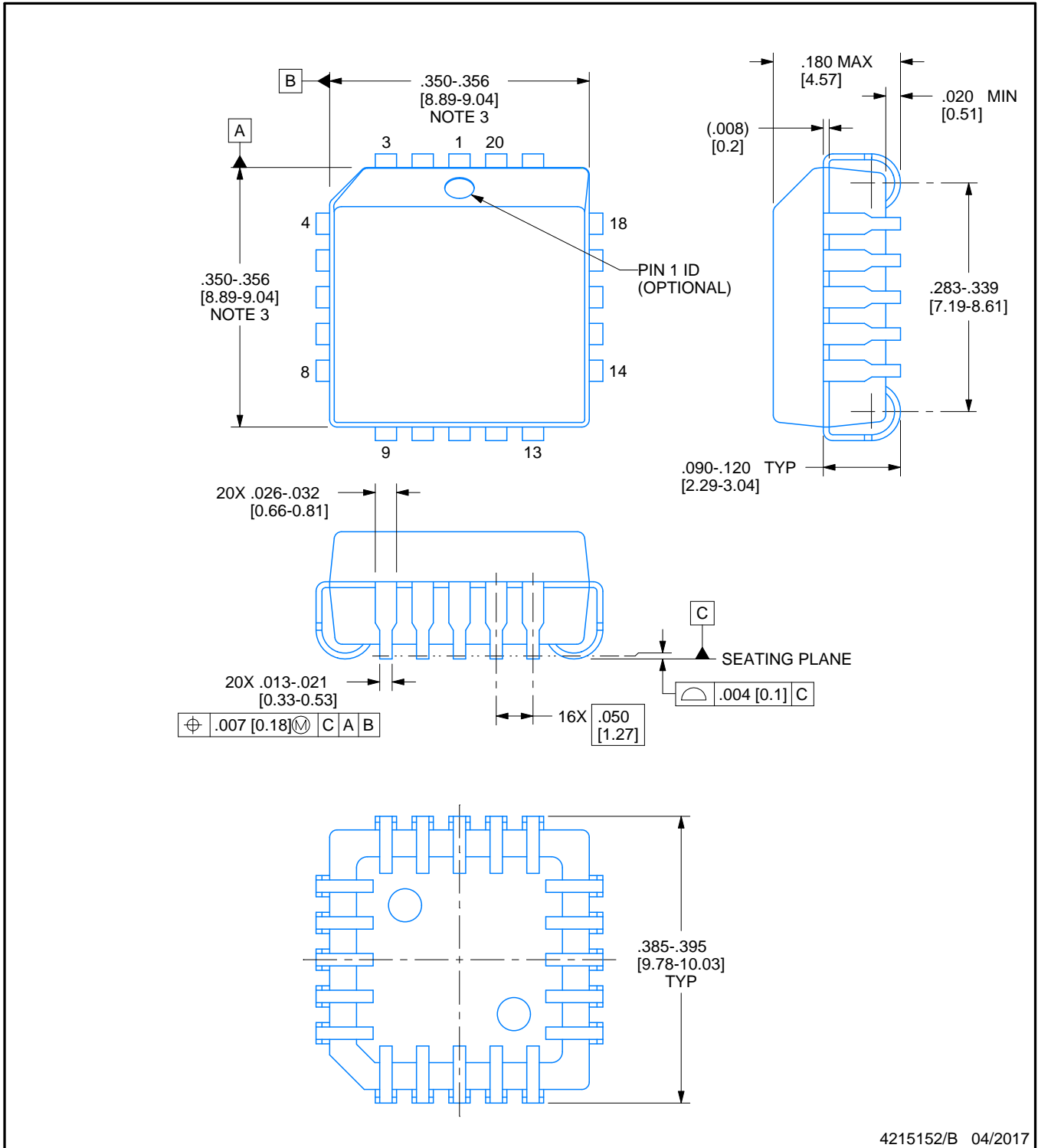


FN0020A

PACKAGE OUTLINE

PLCC - 4.57 mm max height

PLASTIC CHIP CARRIER



4215152/B 04/2017

NOTES:

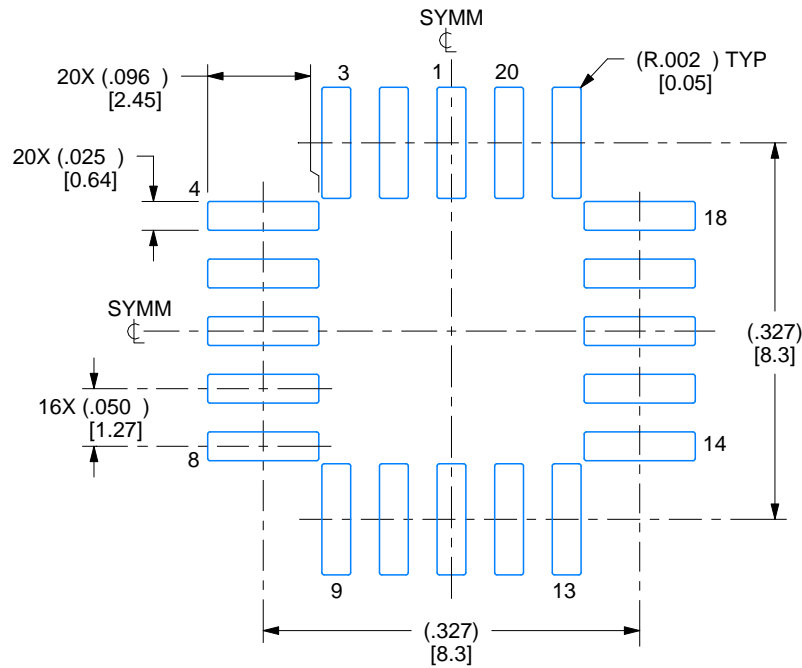
1. All linear dimensions are in inches. Any dimensions in brackets are in millimeters. Any dimensions in parenthesis are for reference only. Controlling dimensions are in inches. Dimensioning and tolerancing per ASME Y14.5M.
2. This drawing is subject to change without notice.
3. Dimension does not include mold protrusion. Maximum allowable mold protrusion .01 in [0.25 mm] per side.
4. Reference JEDEC registration MS-018.

EXAMPLE BOARD LAYOUT

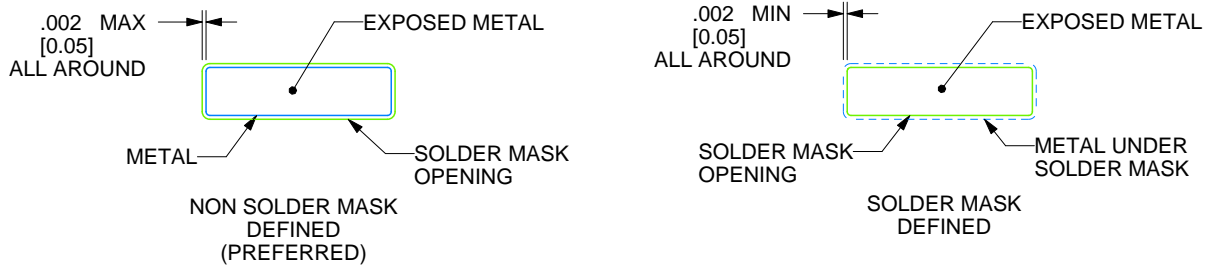
FN0020A

PLCC - 4.57 mm max height

PLASTIC CHIP CARRIER



LAND PATTERN EXAMPLE
EXPOSED METAL SHOWN
SCALE:6X



SOLDER MASK DETAILS

4215152/B 04/2017

NOTES: (continued)

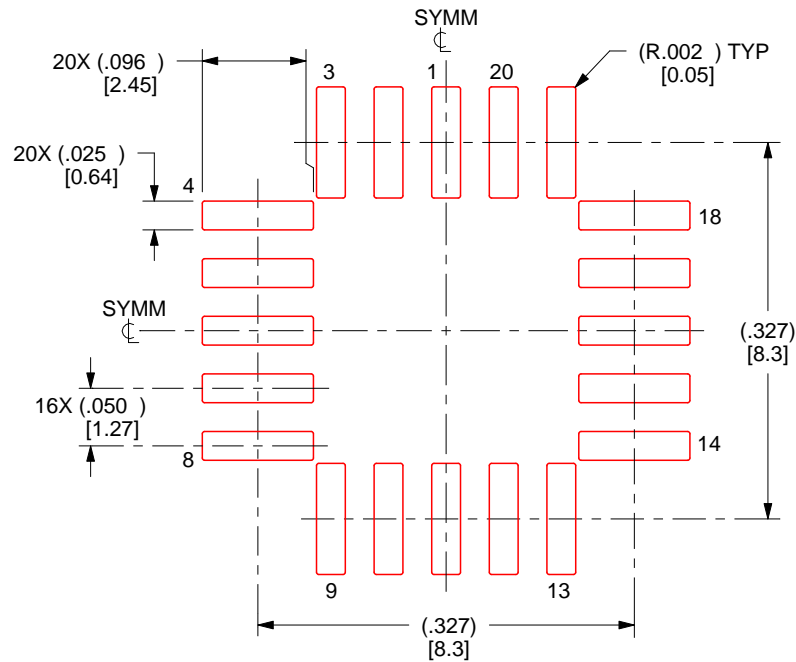
- Publication IPC-7351 may have alternate designs.
- Solder mask tolerances between and around signal pads can vary based on board fabrication site.

EXAMPLE STENCIL DESIGN

FN0020A

PLCC - 4.57 mm max height

PLASTIC CHIP CARRIER



SOLDER PASTE EXAMPLE
BASED ON 0.125 mm THICK STENCIL
SCALE:6X

4215152/B 04/2017

NOTES: (continued)

7. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.
8. Board assembly site may have different recommendations for stencil design.

N (R-PDIP-T**)

PLASTIC DUAL-IN-LINE PACKAGE

16 PINS SHOWN



- NOTES:
- A. All linear dimensions are in inches (millimeters).
 - B. This drawing is subject to change without notice.
 - C Falls within JEDEC MS-001, except 18 and 20 pin minimum body length (Dim A).
 - D The 20 pin end lead shoulder width is a vendor option, either half or full width.

4040049/E 12/2002

DW0020A



PACKAGE OUTLINE

SOIC - 2.65 mm max height

SOIC



4220724/A 05/2016

NOTES:

1. All linear dimensions are in millimeters. Dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
2. This drawing is subject to change without notice.
3. This dimension does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0.15 mm per side.
4. This dimension does not include interlead flash. Interlead flash shall not exceed 0.43 mm per side.
5. Reference JEDEC registration MS-013.

EXAMPLE BOARD LAYOUT

DW0020A

SOIC - 2.65 mm max height

SOIC



LAND PATTERN EXAMPLE
SCALE:6X



SOLDER MASK DETAILS

4220724/A 05/2016

NOTES: (continued)

- 6. Publication IPC-7351 may have alternate designs.
- 7. Solder mask tolerances between and around signal pads can vary based on board fabrication site.

EXAMPLE STENCIL DESIGN

DW0020A

SOIC - 2.65 mm max height

SOIC



SOLDER PASTE EXAMPLE
BASED ON 0.125 mm THICK STENCIL
SCALE:6X

4220724/A 05/2016

NOTES: (continued)

8. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.
9. Board assembly site may have different recommendations for stencil design.

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